AF

ATRORNEY DOCKET NO: AMKOR-052RCE
TIPLE: LEADFRAME AND SEMICONDUCTOR PACKAGE WITH IMPROVED
COLDER JOINT STRENGTH

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5 2005 H	d. Dadudian Andre (1995)	i. no persons are required to respond t	U.S. Patent and Tr	ademark Office: U	PTO/SB/21 (09-04) through 07/31/2006. OMB 0651-0031 I.S. DEPARTMENT OF COMMERCE	
Under the Paperwo	rk Reduction Act of 1995	Application Number		687,00	_	
TRAN	ISMITTAL	Filing Date	10/13/20	000		
F	ORM	First Named Inventor	Tae Hec	Tae Heon Lee		
		Art Unit	2814			
the he wood for all con	rmanandanaa affar initial	Examiner Name	Nguyen	Nguyen, Dillinh P.		
(to be used for all correspondence after initial filing)  Total Number of Pages in This Submission		Attorney Docket Num	Las	AMKOR-052RCE		
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X Amendment/Reply		Petition	Petition		I Communication to TC I Notice, Brief, Reply Brief)	
V		Petition to Convert to a			etary Information	
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This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and1.14. This collection is estimated to 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Application No.: 09/687,048
Attorney Docket: AMKOR-052RCE

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Tae Heon Lee	)	Confirmation No.	1120
Serial No.:	09/687,048	)	Art Unit:	2814
Filed:	10/13/2000	)	Examiner:	Nguyen, Dilinh P
For:	Leadframe and Semiconductor Package With Improved Solder Joint Strength	)		

## AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. §1.116

Mail Stop AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action mailed April 22, 2005 in relation to the above-identified patent application, please amend the above-identified application as follows: